SDLS076

- Synchronous Parallel Load
- Positive-Edge-Triggered Clocking
- Parallel Inputs and Outputs from Each Flip-Flop
- **Direct Overriding Clear**
- J and K Inputs to First Stage
- Complementary Outputs from Last Stage
- For Use in High Performance: Accumulators/Processors Serial-to-Parallel, Parallel-to-Serial Converters

description

These 4-bit registers feature parallel inputs, parallel outputs, J-K serial inputs, shift/load (SH/LD) control input, and a direct overriding clear. All inputs are buffered to lower the input drive requirements. The register has two modes of operation:

Parallel (broadside) load Shift (in the direction QA toward QD)

Parallel loading is accomplished by applying the four bits of data and taking SH/LD low. The data is loaded into the associated flip-flop and appears at the outputs after the positive transition of the clock input. During loading, serial data flow is inhibited.

Shifting is accomplished synchronously when SH/LD is high. Serial data for this mode is entered at the J- \overline{K} inputs. These inputs permit the first stage to perform as a J-K, D-, or T-type flip-flop as shown in the function table.

The high-performance '\$195, with a 105-megahertz typical maximum shift-frequency, is particularly attractive for very-high-speed data processing systems. In most cases existing systems can be upgraded merely by using this Schottky-clamped shift register.

FUNCTION TABLE

	_	OUTPUTS											
CLEAR	SHIFT/ SER		SERIAL PARALLEL							~			
LLEAN	LOAD	CLOCK	L	ĸ	A	B	С	D.	QA	Q _B	QC	QD	α _D
	X	×	×	x	X	x	х	X	L		L	Ľ	н
н	L	t	x	x	a	ь	c	d .	а	b	с	d	d
н	н	L	x	x	x	х	х	x	QA0	0 ₈₀	aco	a _{D0}	ā _{D0}
н	н	T I	L	н	х	х	х	x	QAD	\mathbf{a}_{A0}	$\mathbf{Q}_{\mathbf{B}\mathbf{D}}$	$\boldsymbol{\alpha}_{Cn}$	ā _{Cn}
н	н		L	L	х	х	х	х	L	\mathbf{Q}_{An}	Q _{Bn}	O _{Cn}	ã _{Cn}
н	н	T	н	н	х	х	х	X	н	QAn	QBn	QCn	ā _{Cn}
н	н	1	н	L	x	х	х	х	ā _{An}	Q _{An}	0 _{Bn}	Q _{Cn}	ā _{Cn}

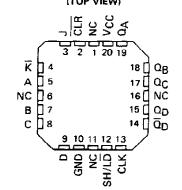
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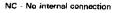
SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195 **4-BIT PARALLEL-ACCESS SHIFT REGISTERS**

MARCH 1974-REVISED MARCH 1988

SN54195, SN54LS195A, SN54S195 . . . J OR W PACKAGE SN74195 N PACKAGE \$N74LS195A, SN74S195 ... D OR N PACKAGE (TOP VIEW)

SN54LS195, SN54S195 ... FK PACKAGE (TOP VIEW)





TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
ʻ195	39 MHz	195 mW
'LS195A	39 MHz	70 mW
'S195	105 MHz	350 mW

H = high level (steady state)

L = low level (steady state)

X = irrelevant (any input, including transitions)

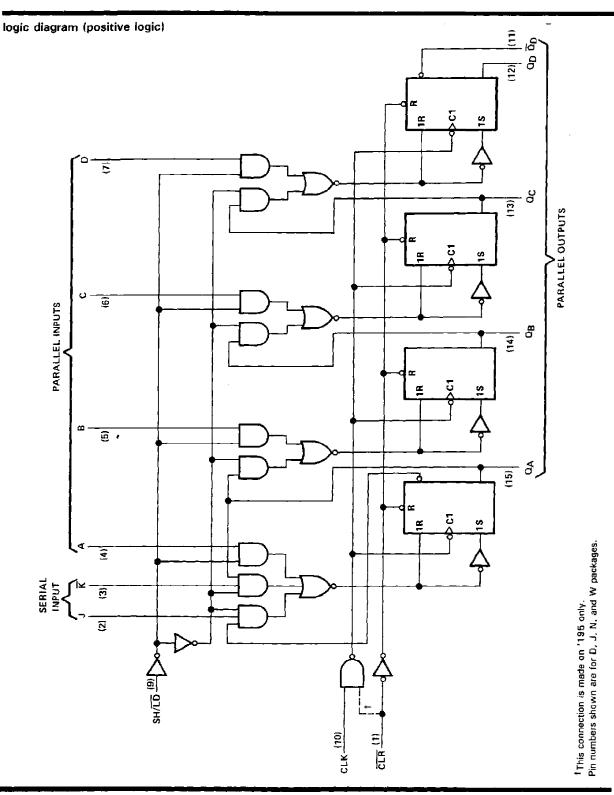
t = transition from low to high level

- a, b, c, d = the level of steady-state input at A, B,C, or D, respectively
- $Q_{A0}, Q_{B0}, Q_{C0}, Q_{D0}$ = the level of Q_A, Q_B, Q_C . or Q_D, respectively, before the indicated steadystate input conditions were established

 $a_{An}, a_{Bn}, a_{Cn} =$ the level of $a_A, a_B,$ or $a_C,$ respectively, before the mostrecent transition of the clock

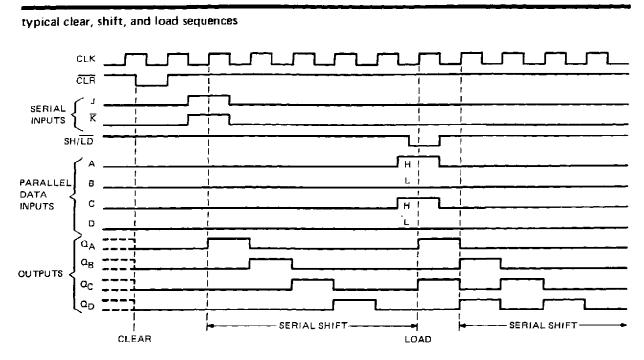


SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195 4-BIT PARALLEL-ACCESS SHIFT REGISTERS

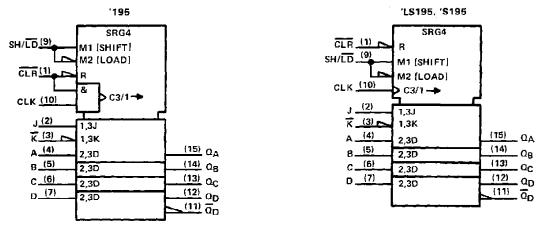


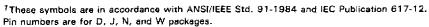


SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195 4-BIT PARALLEL-ACCESS SHIFT REGISTERS



logic symbols[†]

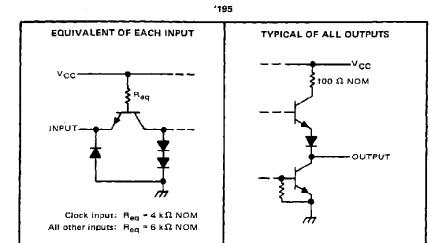




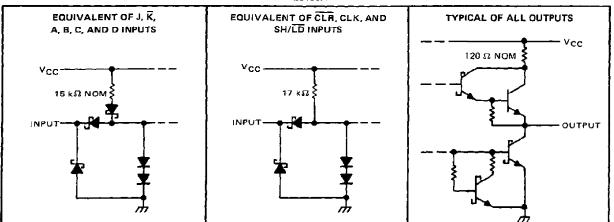


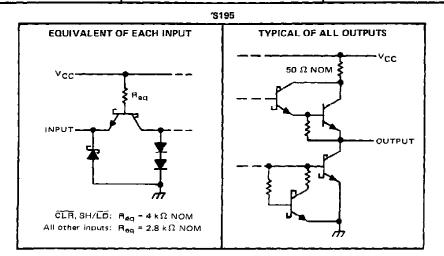
SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195 4-BIT PARALLEL-ACCESS SHIFT REGISTERS













absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)				 :	 7 V
Input voltage	,	• • •	. .	 	 5.5 V
Operating free-air temperature range:	SN54195			 	 –55°C to 125°C
	SN74195			 	 . 0°C to 70°C
Storage temperature range				 	 –65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5419	5				
		MIN	NOM	MAX	MIN	NOM	MAX	דואט
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		1		-800			-800	μA
Low-level output current, IOL		1		16	·····		16	mA
Clock frequency, fclock		0		30	0		30	MHz
Width of clock input pulse, tw(clock)	······································	16			16			пs
Width of clear input pulse, tw(clear)		12			12			ns
	Shift/load	25			25			
Setup time, t _{su} (see Figure 1)	Serial and parallel data	20			20			ns
	Clear inactive-state	25			25			
Shift/load release time, trelease (see Figure 1)				10			10	n\$
Serial and parallel data hold time, th (see Figure 1)		0			0			ns
Operating free-air temperature, TA		55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]	MIN	TYP‡	MAX	UNIT
ViH	High-level input voltage		2			V V
VIL	Low-level input voltage		-		0.8	V
VIK	Input clamp voltage	V _{CC} = MIN, I _I = -12 mA	1		-1.5	V
∨он	High-level Output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -800 μA	2.4	3.4		v
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA		0.2	0.4	v
4	Input current at maximum input voltage	V _{CC} = MAX, V ₁ = 5.5 V			1	mΑ
Чн	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V			40	μA
11	Low-level input current	V _{CC} = MAX, V ₁ = 0.4 V	1		-1.6	mA
100	Short-circuit output current §	SN5419	-20		-67	_
los		VCC = MAX SN 7419	- 18		-57	mA
1CC	Supply current	VCC = MAX, See Note 2		39	63	mA

 † For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

8 Not more than one output should be shorted at a time,

NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J, K, and data inputs. I_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clear and then applying a momentary ground, followed by 4.5 V, to clock.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax Maximum clock frequency	$C_1 = 15 \rho F_1$	30	39		MHz
tPHL Propagation delay time, high-to-low-level output from clear	=		19	30	лş
tPLH Propagation delay time, low-to-high-level output from clock	R_ = 400 S2,	<u> </u>	14	22	ns
tPHL Propagation delay time, high-to-low-level output from clock	See Figure 1		17	26	ns



SN54LS195A, SN74LS195A **4-BIT PARALLEL ACCESS SHIFT REGISTERS**

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .														7 V
Input voltage														
Operating free-air temperature range:	SN54LS195A										-5	5°(C to	1 25°C
	SN74L\$195A					,		,				0'	°Ct	o 70°C
Storage temperature range											-6	5°(C to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SI	154LS1	95A	S	1		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5,5	4.75	5	5.25		
High-level output current, IOH			-400		_	-400	μA	
Low-level output current, IOL		1		4	1		8	mA
Clock frequency, fclock		0		30	0		30	MHz
Width of clock or clear pulse, tw(clock)	16			16			ns	
Width of clear input pulse, tw(clear)		12			12			ns
	Shift/load	25			25			
Setup time, t _{su} (see Figure 1)	Serial and parallel data	15			15			ns
	Clear inactive-state	25			25			
Shift/load release time, trelease (see Figure 1)				10			20	⊓s
Serial and parallel data hold time, th (see Figure 1)		0			0			ns
Operating free-air temperature, TA		-65		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN	54LS19	5A	SN			
	PARAMETER	(E)		7169 .	MIN	TYP [‡]	MAX	MIN	ŦΥΡ‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
Vik	Input clamp voltage	Vcc = MIN,	lı = −18 mA				-1.5	1		-1.5	V
∨он	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	VIH = 2 V, I _{OH} = -400	μA	2.5	3.4		2.7	3.4		Υ.
		VCC = MIN,	VIH = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
VOL	Low-level output voltage	VIL = VIL max		IOL = 8 mA					0.35	0.5	v
4	Input current at maximum input voltage	V _{CC} = MAX,	V1 = 7 V	• •			0.1			0.1	mA
411	High-level input current	VCC = MAX.	VI = 2.7 V		1		20			20	μA
46	Low-level input current	V _{CC} = MAX,	Vj = 0.4 V				-0.4			-0.4	mА
los	Short-circuit output current§	V _{CC} = MAX			-20		-100	-20		-100	mА
lcc	Supply current	V _{CC} = MAX,	See Note 2			14	21		14	21	mА

¹ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
² All typical values are at V_{CC} - 5 V, T_A = 25 C.
³ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second,
NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J. K, and data inputs, i_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clock.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax. Maximum clack frequency		30	39		MHZ
tPHL Propagation delay time, high-to-low-level output from clear	$R_{\rm I} = 2 k\Omega,$		19	30	ns
tPLH Propagation delay time, low-to-high-level output from clock	See Figure 1		14	22	ns
tPHL Propagation delay time, high-to-low-level output from clock	Que rigure r		17	26	ns



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)											7V
Input voltage											
Operating free-air temperature range:	SN54S195			-						,	–55°C to 125°C
											0°C to 70°C '
Storage temperature range		 -	, .			 -			-		~65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		S S	SN54S19	95	S	SN74S195		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH		T		1	[-1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, fclock		0		70	0		70	MHz
Width of clock input pulse, tw(clock)	7			7			ns	
Width of clear input pulse, tw(clear)	12			12			ns	
	Shift/load	11			11			
Setup time, t _{su} (see Figure 1)	Serial and parallel data				5			ns
	Clear inactive-state	9			9			
Shift/load release time, trelease (see Figure 1)				2	[6	ns
Serial and parallel data hold time, th (see Figure 1)					3			ns
Operating free-air temperature, TA		55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			MIN	TYP‡	MAX	UNIT		
V _{IH}	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	V
ViK	Input clamp voltage	V _{CC} = MIN,	I _I =18 mA				-1.2	V
VOH High-level output voltage		V _{CC} = MIN,	VIH = 2 V,	SN54S195	2.5	3.4		l v
	High-level output voltage	V _{IL} = 0.8 V,	1 _{0H} = -1 mA	SN74S195	2.7	3.4		
VOL I		V _{CC} = MIN,	V _{IH} ≠ 2 V,					- v
	Low-level output voltage	VIL = 0.8 V,	1 _{0L} = 20 mA)L = 20 mA			0.5	ľ
۱ _۱	Input current at maximum input voltage	V _{CC} - MAX,	V ₁ = 5.5 V				t	mA
Чн	High-level input current	VCC = MAX,	V ₁ = 2.7 V				50	μA
<u>۱</u> ۲	Low-level input current	V _{CC} = MAX,	V _I = 0.5 V				-2	mΑ
los	Short-circuit output current §	V _{CC} = MAX		······································	-40		-100	mА
			0	SN54S195		70	99	-
icc	Supply current	V _{CC} = MAX,	See Note 2	SN74\$195		70	109	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 \ddagger All typical values are at V_{CC} = 5 V, T_A = 25²C.

.....

\$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open, shift/load grounded, and 4.5 V applied to the J, \overline{K} , and data inputs, I_{CC} is measured by applying a momentary ground, followed by 4.5 V, to clear, and then applying a momentary ground, followed by 4.6 V, to clock.

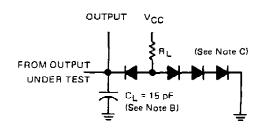
switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax Maximum clock frequency	C ₁ = 15 pF,	70	105		MHz
tpHL Propagation delay time, high-to-low-level output from clear	$R_{\rm I} = 280 \ \Omega_{\rm c}$		12.5	18.5	ns
tPLH Propagation delay time, low-to-high-level output from clock	See Figure 1		8	12	ns
tpHL Propagation delay time, high-to-low-level output from clock			11	16.5	N\$

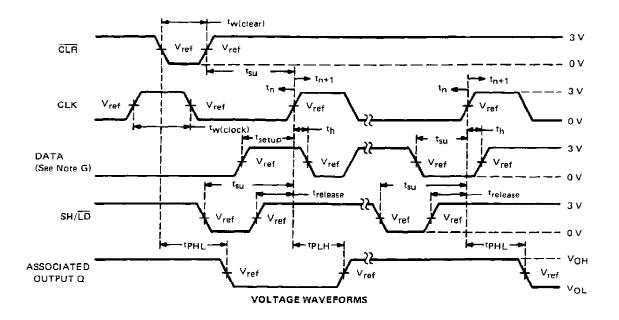


SN54195, SN54LS195A, SN54S195, SN74195, SN74LS195A, SN74S195 **4-BIT PARALLEL-ACCESS SHIFT REGISTERS**

PARAMETER MEASUREMENT INFORMATION



LOAD FOR OUTPUT UNDER TEST



NOTES: A. The clock pulse generator has the following characteristics: $Z_{out} \approx 50 \ \Omega$ and PRR ≤ 1 MHz. For '195, $t_f \leq 7$ ns and $t_f \leq 7$ ns. For 'LS195A, $t_f \leq 15$ ns and $t_f \leq 6$ ns. For 'S195, $t_f = 2.5$ ns and $t_f = 2.5$ ns. When testing f_{max} , vary the clock PRR.

- B. Ci includes probe and jig capacitance.
- C. All diodes are 1N3064 or equivalent.
- D. A clear pulse is applied prior to each test.
- E. For '195 and 'S195, $V_{ref} = 1.5 V$; for 'LS195A, $V_{ref} = 1.3 V$. F. Propagation delay times (tpLH and tpHL) are measured at t_{n+1}. Proper shifting of data is verified at t_{n+4} with a functional test.
- G. J and K inputs are tested the same as data A, B, C, and D inputs except that shift/load input remains high.
- H. t_n = bit time before clocking transition.
 - t_{n+1} = bit time after one clocking transition. t_{n+4} = bit time after four clocking transitions.

FIGURE 1-SWITCHING TIMES





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30602B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602B2A	Samples
JM38510/30602BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602BEA	Samples
JM38510/30602BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602BEA	Samples
M38510/30602B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602B2A	Samples
M38510/30602B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602B2A	Samples
M38510/30602BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602BEA	Samples
M38510/30602BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30602BEA	Samples
SN54LS195AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS195AJ	Samples
SN54LS195AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS195AJ	Samples
SNJ54LS195AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS195AJ	Samples
SNJ54LS195AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS195AJ	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.



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PACKAGE OPTION ADDENDUM

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/30602B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30602B2A	FK	LCCC	20	55	506.98	12.06	2030	NA

FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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